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2/25/2009

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Akihiko ENDO et al.

Art Unit : 2829

Appl. No. : 10/570,665

Examiner : Shaun M CAMPBELL

Filed : March 6, 2006

Confirmation No. : 1241

For : BONDED WAFER AND ITS MANUFACTURING METHOD

SUPPLEMENTAL RESPONSE UNDER 37 C.F.R. 1.116

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop AF
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

Further to the filing of the response on December 10, 2008 to the Final Office Action from the U.S. Patent and Trademark Office dated September 10, 2008, and the mailing of the Advisory Action on January 7, 2009, Applicants submit this supplemental response following a January 26, 2009 telephone interview.

Applicants hereby request an extension of time for two months to extend the period for response until February 10, 2009, and are concurrently filing a formal Request for Extension of Time for two months accompanied by the government fee. If for any reason the formal Request for Extension of Time is not associated with the file at the Patent and Trademark Office and/or if any extension of time and/or any fee is required to maintain the pendency of the application, including any required extension of time for entry of an Examiner's Amendment, this is an express request for any required extension of time and authorization to charge any required fee to maintain the pendency of the application to Deposit Account No. 19-0089.

Remarks begin on page 3 of this paper.

Reconsideration and allowance of the application in view of the following remarks are respectfully requested.